Preferred Device

Silicon Hot-Carrier Diodes

Schottky Barrier Diodes

These devices are designed primarily for high-efficiency UHF and VHF detector applications. They are readily adaptable to many other fast switching RF and digital applications. They are supplied in an inexpensive plastic package for low-cost, high-volume consumer and industrial/commercial requirements. They are also available in a Surface Mount package.

Features

- Extremely Low Minority Carrier Lifetime 15 ps (Typ)
- Very Low Capacitance 1.0 pF @ $V_R = 20 \text{ V}$
- High Reverse Voltage to 70 V
- Low Reverse Leakage 200 nA (Max)
- AEC Qualified and PPAP Capable
- S Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements
- Pb-Free Packages are Available*

MAXIMUM RATINGS

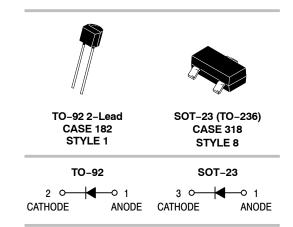
| Rating | Symbol | Value | Unit |
|--|------------------|-------------------|-------------|
| Reverse Voltage | V _R | 70 | V |
| Forward Power Dissipation @ T _A = 25°C MBD701 MMBD701L, SMMBD701L Derate above 25°C MBD701 | P _F | 280 200 2.8 | mW mW/°C |
| MMBD701L, SMMBD701L | | 2.0 | |
| Operating Junction Temperature Range | TJ | -55 to +125 | °C |
| Storage Temperature Range | T _{stg} | -55 to +150 | °C |

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

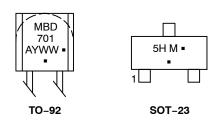


ON Semiconductor®

http://onsemi.com



MARKING DIAGRAMS



A = Assembly Location

Y = Year

WW = Work Week

5H = Device Code (SOT-23)

M = Date Code*

■ = Pb-Free Package

(Note: Microdot may be in either location)

*Date Code orientation and/or overbar may vary depending upon manufacturing location.

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 2 of this data sheet.

Preferred devices are recommended choices for future use and best overall value.

^{*}For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted)

| Characteristic | Symbol | Min | Тур | Max | Unit |
|--|--------------------|-----|------|-----|------|
| Reverse Breakdown Voltage ($I_R = 10 \mu Adc$) | V _{(BR)R} | 70 | _ | - | V |
| Total Capacitance (V _R = 20 V, f = 1.0 MHz) Figure 1 | C _T | - | 0.5 | 1.0 | pF |
| Reverse Leakage (V _R = 35 V) Figure 3 | I _R | - | 9.0 | 200 | nAdc |
| Forward Voltage (I _F = 1.0 mAdc) Figure 4 | V _F | - | 0.42 | 0.5 | Vdc |
| Forward Voltage (I _F = 10 mAdc) Figure 4 | V _F | - | 0.7 | 1.0 | Vdc |

ORDERING INFORMATION

| Device | Package | Shipping [†] |
|--------------|---------------------|-----------------------|
| MBD701 | TO-92 | 1,000 Units / Bulk |
| MBD701G | TO-92 (Pb-Free) | 1,000 Units / Bulk |
| MMBD701LT1 | SOT-23 | 3,000 / Tape & Reel |
| MMBD701LT1G | SOT-23 (Pb-Free) | 3,000 / Tape & Reel |
| SMMBD701LT1G | SOT-23 (Pb-Free) | 3,000 / Tape & Reel |
| MMBD701LT3 | SOT-23 | 10,000 / Tape & Reel |
| MMBD701LT3G | SOT-23 (Pb-Free) | 10,000 / Tape & Reel |

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

TYPICAL ELECTRICAL CHARACTERISTICS

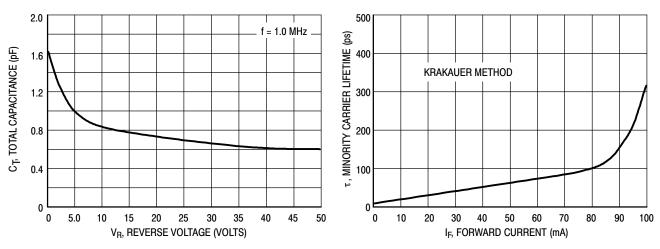


Figure 1. Total Capacitance

Figure 2. Minority Carrier Lifetime

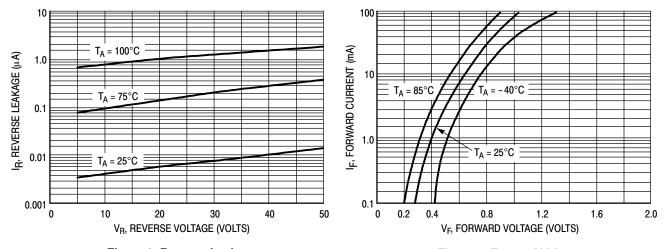


Figure 3. Reverse Leakage

Figure 4. Forward Voltage

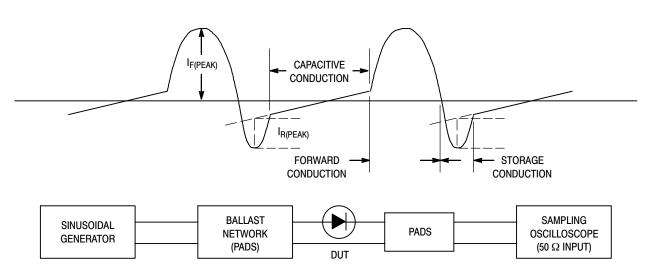
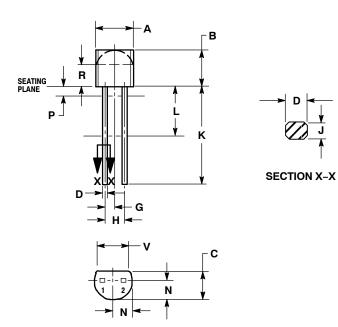


Figure 5. Krakauer Method of Measuring Lifetime

PACKAGE DIMENSIONS

TO-92 (TO-226AC) CASE 182-06

ISSUE L



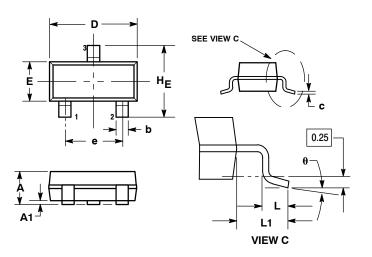
- NOTES:
 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 2. CONTROLLING DIMENSION: INCH.
 3. CONTOUR OF PACKAGE BEYOND ZONE R IS UNCONTROLLED.
 4. LEAD DIMENSION IS UNCONTROLLED IN P AND BEYOND DIMENSION K MINIMUM.

| | INCHES | | MILLIMETERS | | |
|-----|-----------|-------|-------------|-------|--|
| DIM | MIN | MAX | MIN | MAX | |
| Α | 0.175 | 0.205 | 4.45 | 5.21 | |
| В | 0.170 | 0.210 | 4.32 | 5.33 | |
| С | 0.125 | 0.165 | 3.18 | 4.19 | |
| D | 0.016 | 0.021 | 0.407 | 0.533 | |
| G | 0.050 BSC | | 1.27 BSC | | |
| Н | 0.100 BSC | | 2.54 BSC | | |
| J | 0.014 | 0.016 | 0.36 | 0.41 | |
| K | 0.500 | | 12.70 | | |
| L | 0.250 | | 6.35 | | |
| N | 0.080 | 0.105 | 2.03 | 2.66 | |
| P | | 0.050 | | 1.27 | |
| R | 0.115 | | 2.93 | | |
| ٧ | 0.135 | | 3.43 | | |

STYLE 1: PIN 1. ANODE 2. CATHODE

PACKAGE DIMENSIONS

SOT-23 (TO-236) CASE 318-08 **ISSUE AP**



NOTES

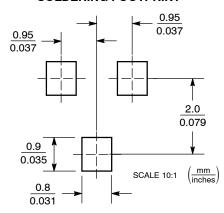
- DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- CONTROLLING DIMENSION: INCH.
 MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH THICKNESS. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF BASE MATERIAL.
- DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE BURRS.

| | MILLIMETERS | | | INCHES | | |
|-----|-------------|------|------|--------|-------|-------|
| DIM | MIN | NOM | MAX | MIN | NOM | MAX |
| Α | 0.89 | 1.00 | 1.11 | 0.035 | 0.040 | 0.044 |
| A1 | 0.01 | 0.06 | 0.10 | 0.001 | 0.002 | 0.004 |
| b | 0.37 | 0.44 | 0.50 | 0.015 | 0.018 | 0.020 |
| С | 0.09 | 0.13 | 0.18 | 0.003 | 0.005 | 0.007 |
| D | 2.80 | 2.90 | 3.04 | 0.110 | 0.114 | 0.120 |
| E | 1.20 | 1.30 | 1.40 | 0.047 | 0.051 | 0.055 |
| е | 1.78 | 1.90 | 2.04 | 0.070 | 0.075 | 0.081 |
| L | 0.10 | 0.20 | 0.30 | 0.004 | 0.008 | 0.012 |
| L1 | 0.35 | 0.54 | 0.69 | 0.014 | 0.021 | 0.029 |
| HE | 2.10 | 2.40 | 2.64 | 0.083 | 0.094 | 0.104 |
| θ | 0° | | 10° | 0° | | 10° |

STYLE 8:

- PIN 1. ANODE 2. NO CONNECTION
 - CATHODE

SOLDERING FOOTPRINT



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